

FIG.1

Related Art

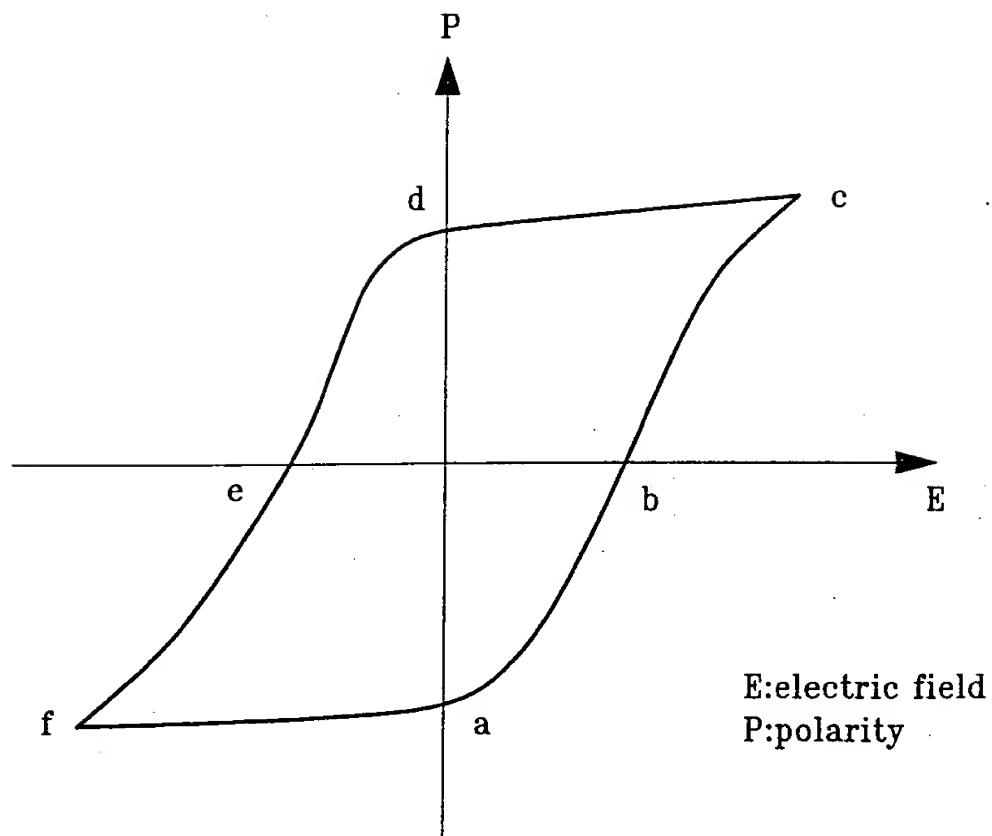


FIG.2
Related Art

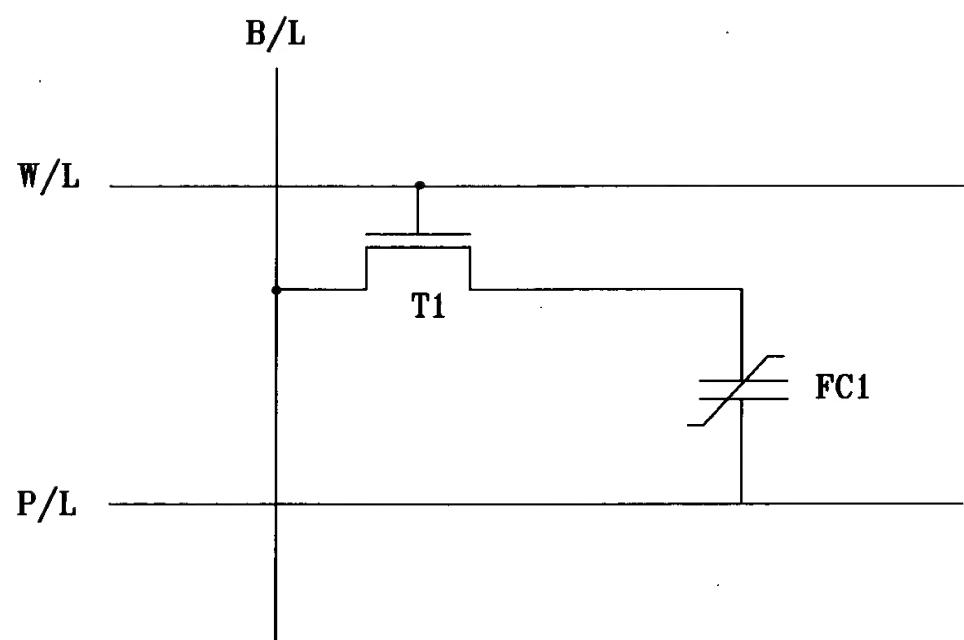


FIG.3a
Related Art

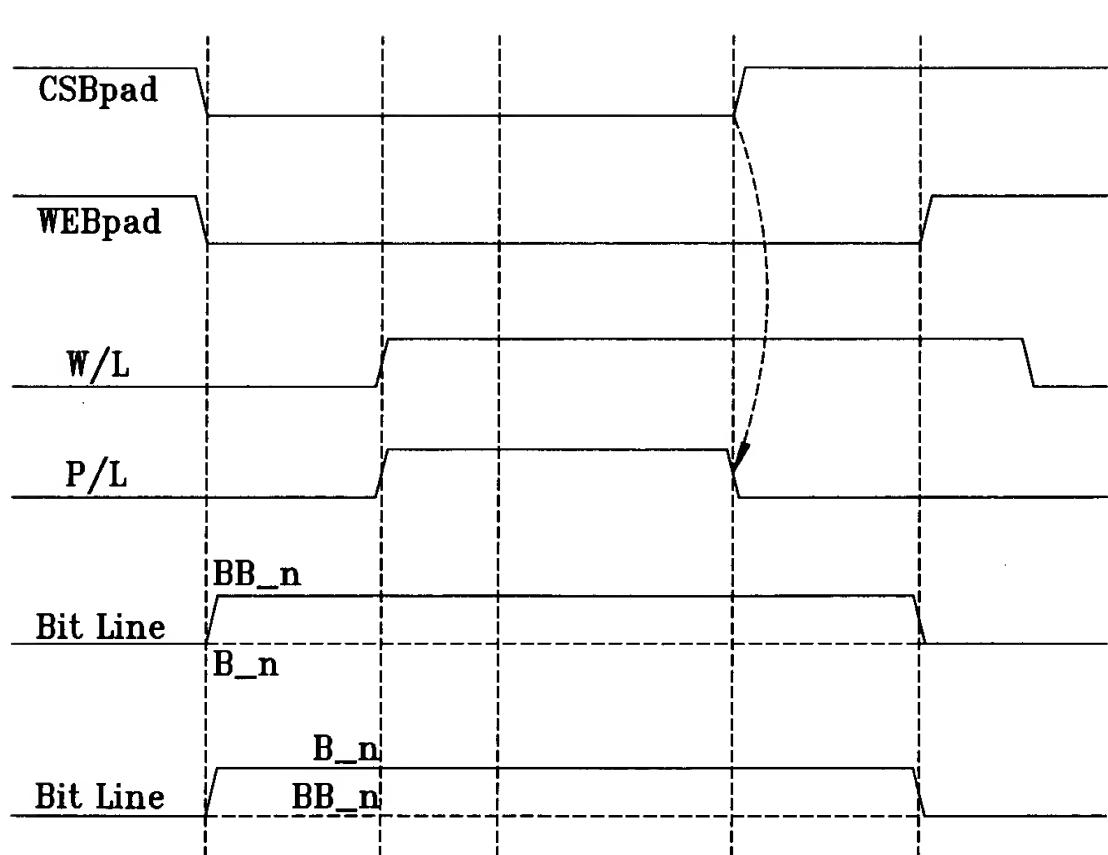


FIG.3b Related Art

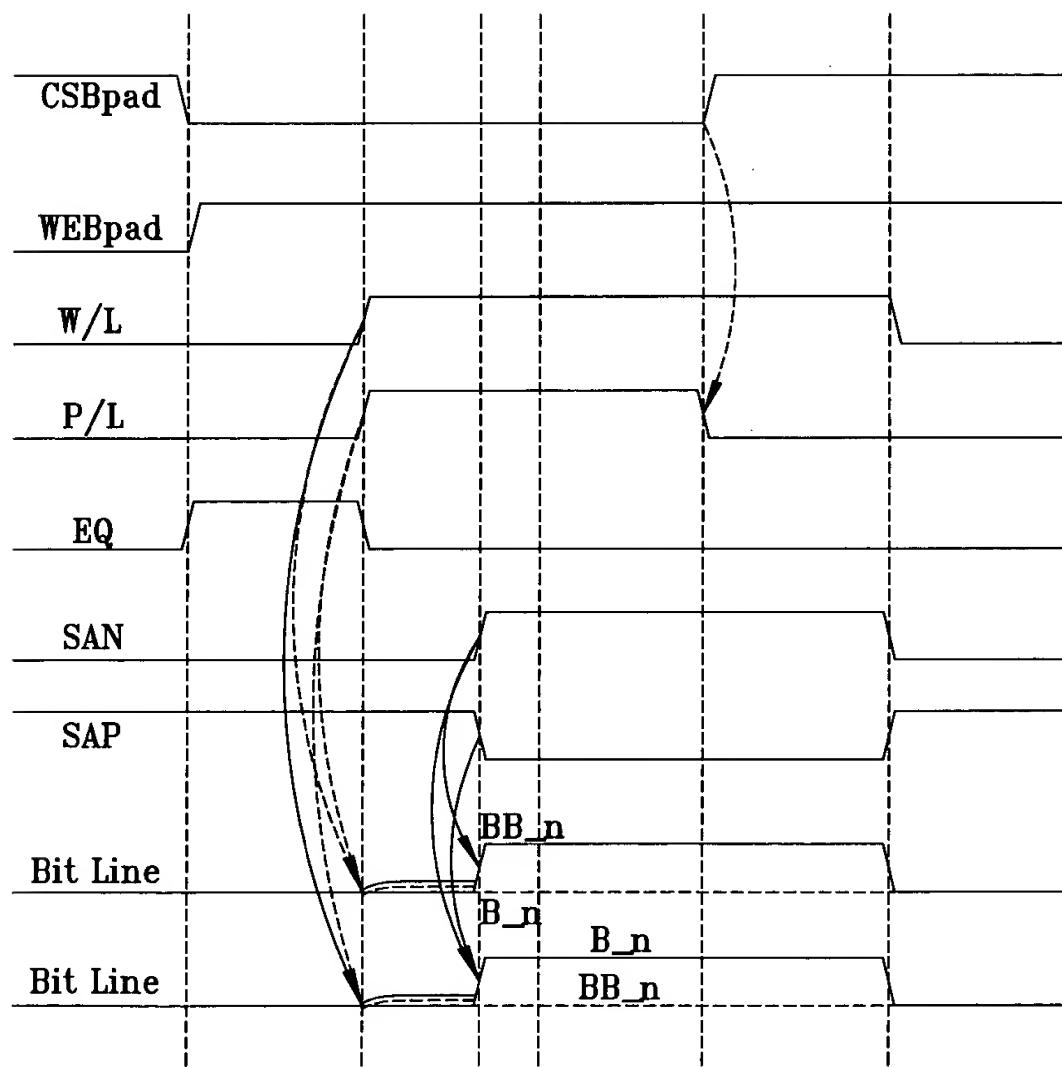


FIG.4a
Related art

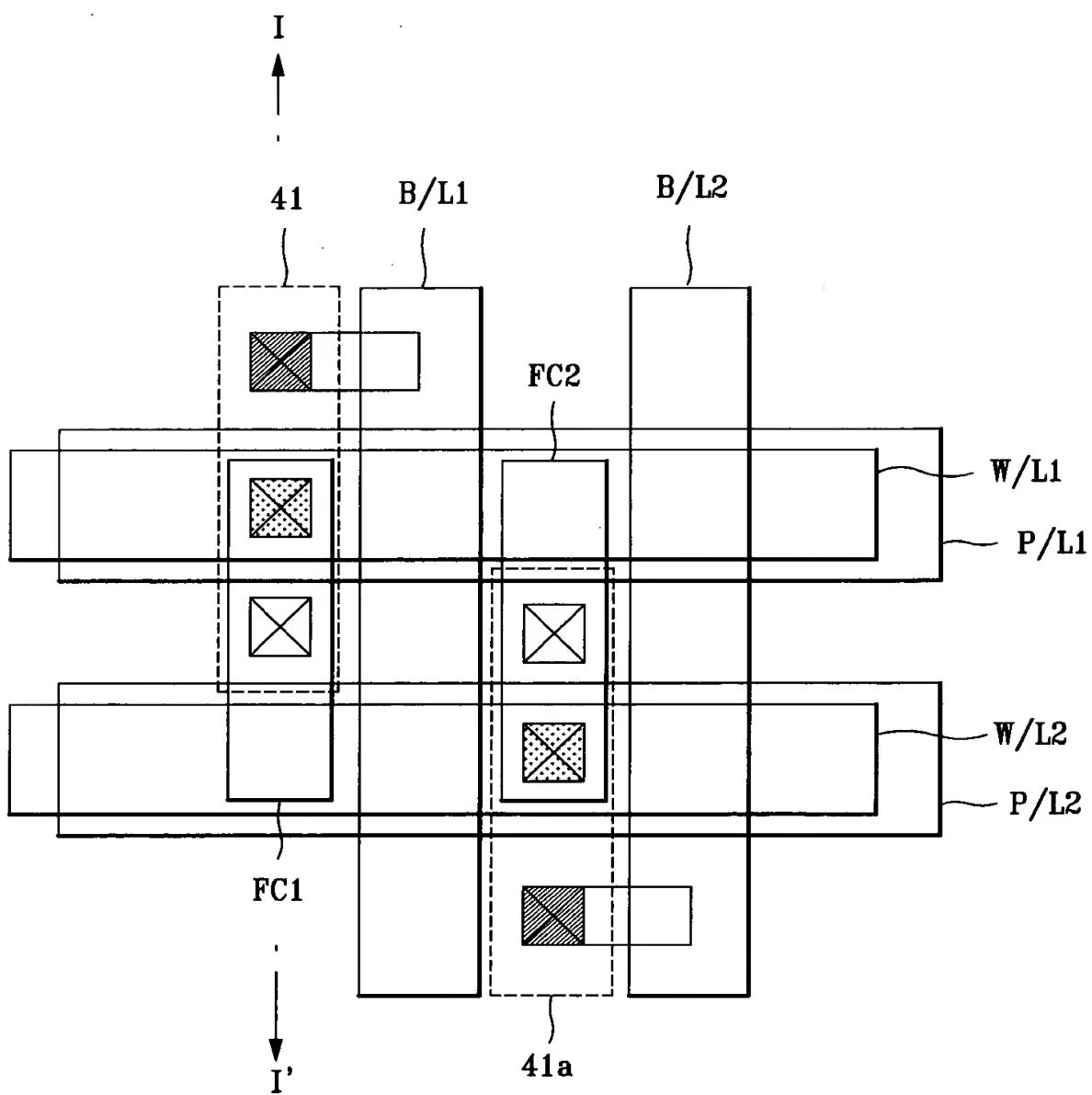


FIG.4b
related art

08725256-132000

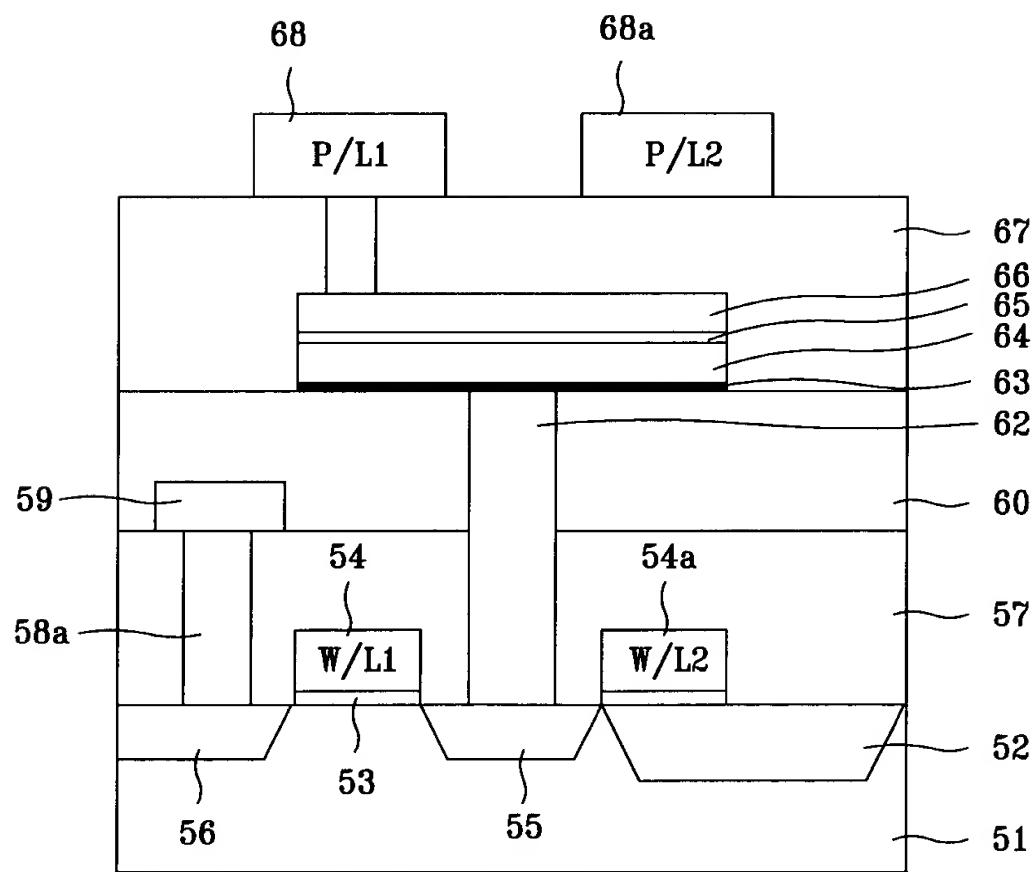


FIG.5a
Related Art

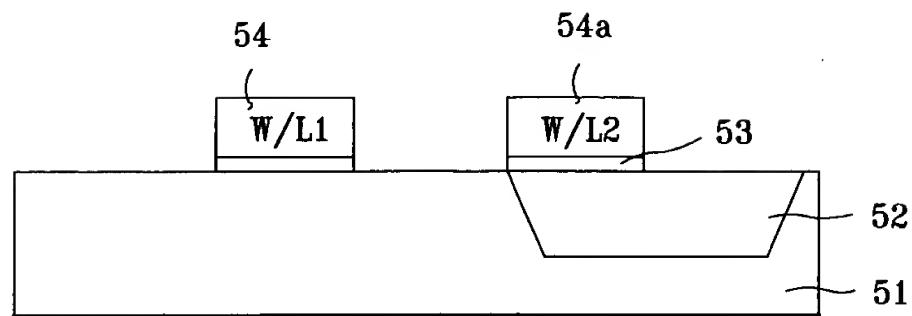


FIG.5b
Related Art

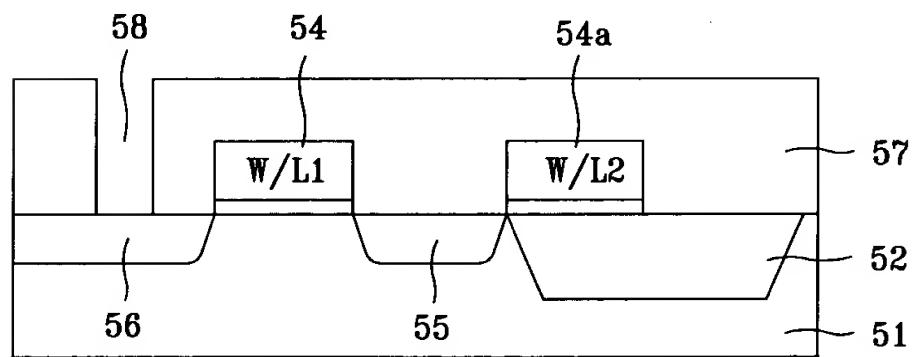


FIG.5c
Related Art

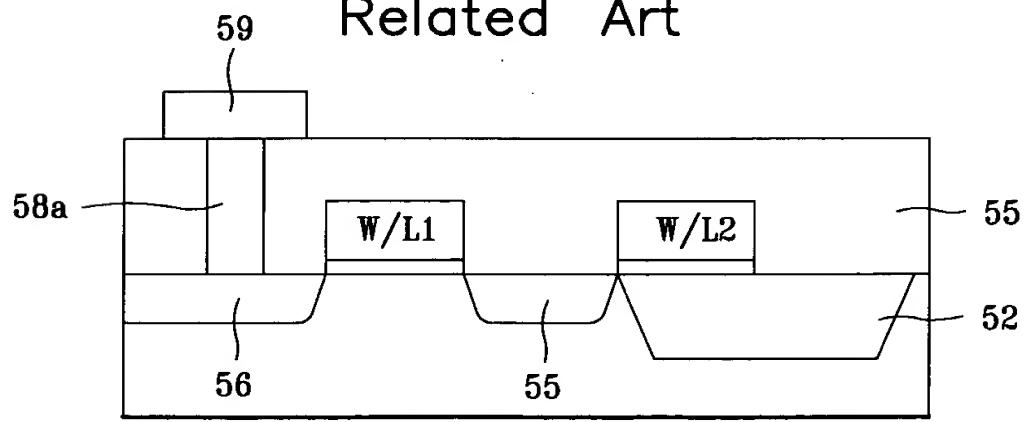


FIG.5d
Related Art

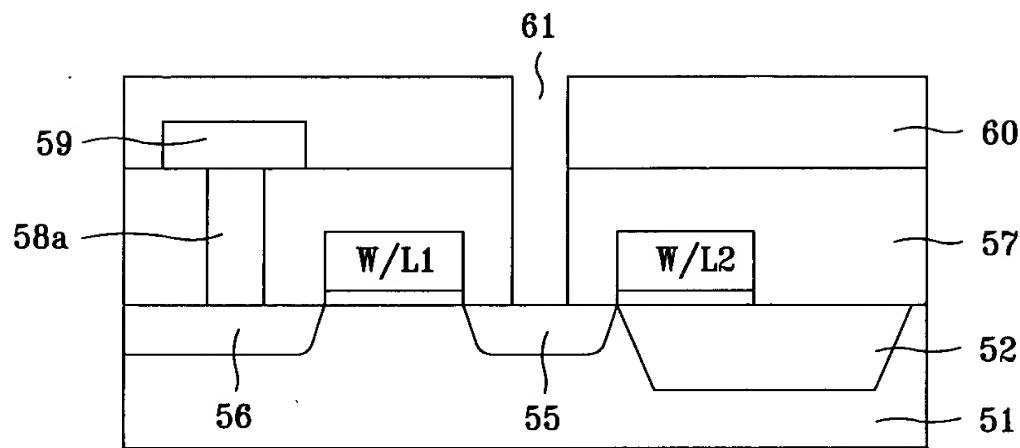


FIG.5e
Related Art

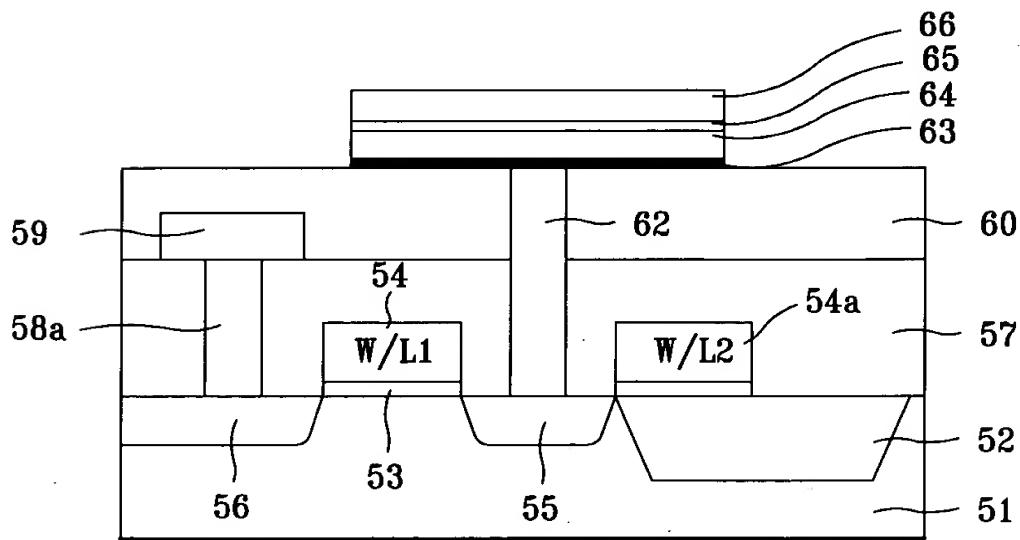


FIG.5f

Related Art

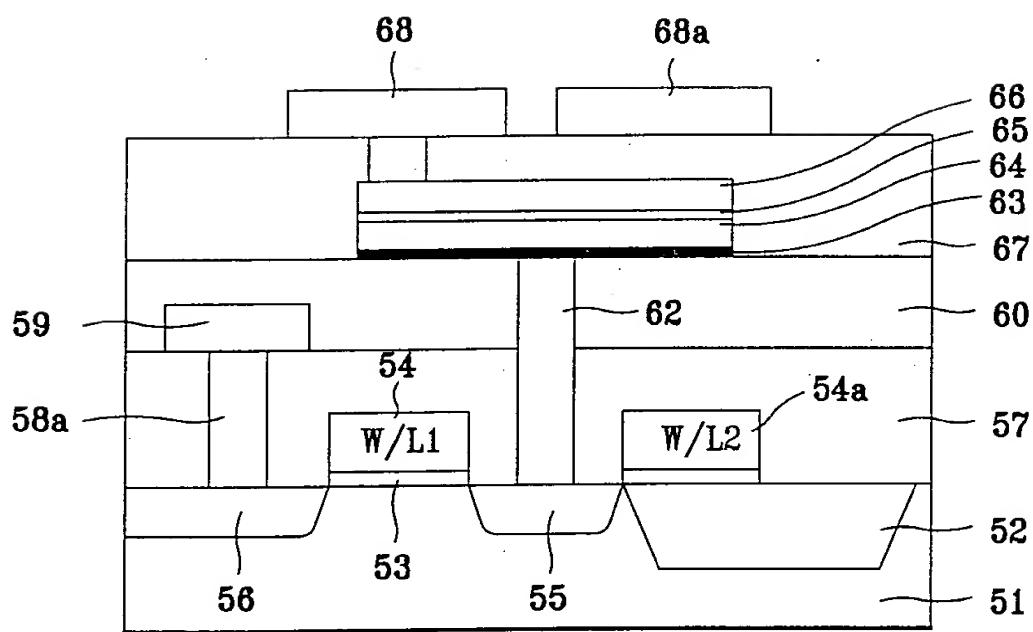


FIG.6

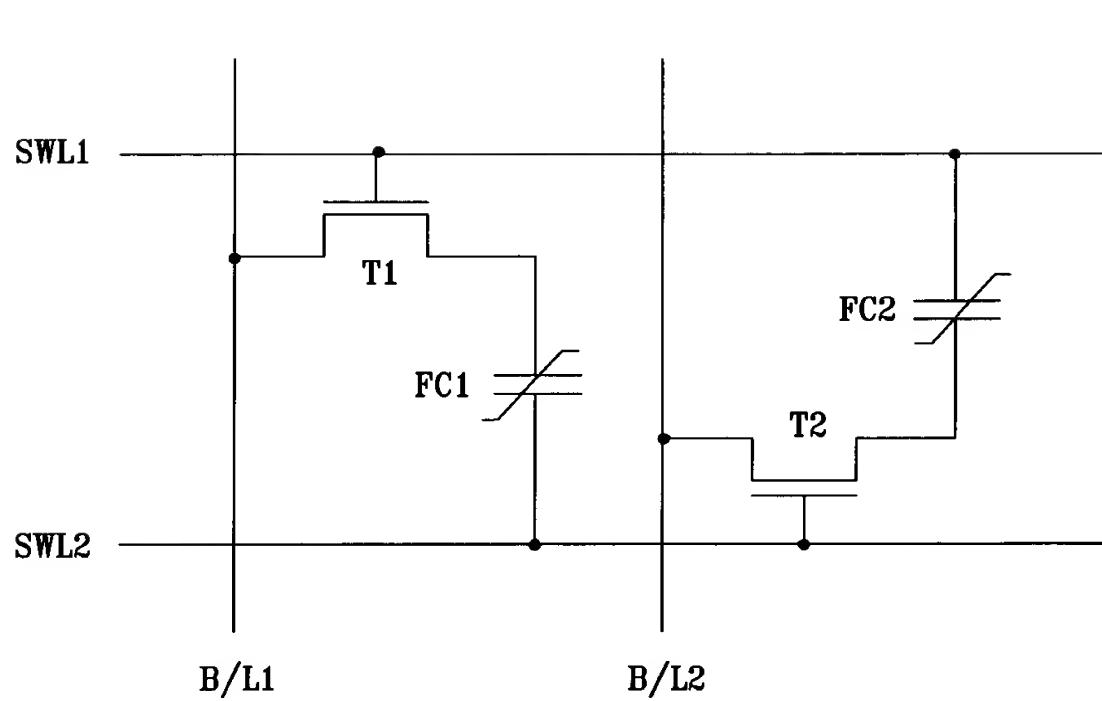


FIG. 7

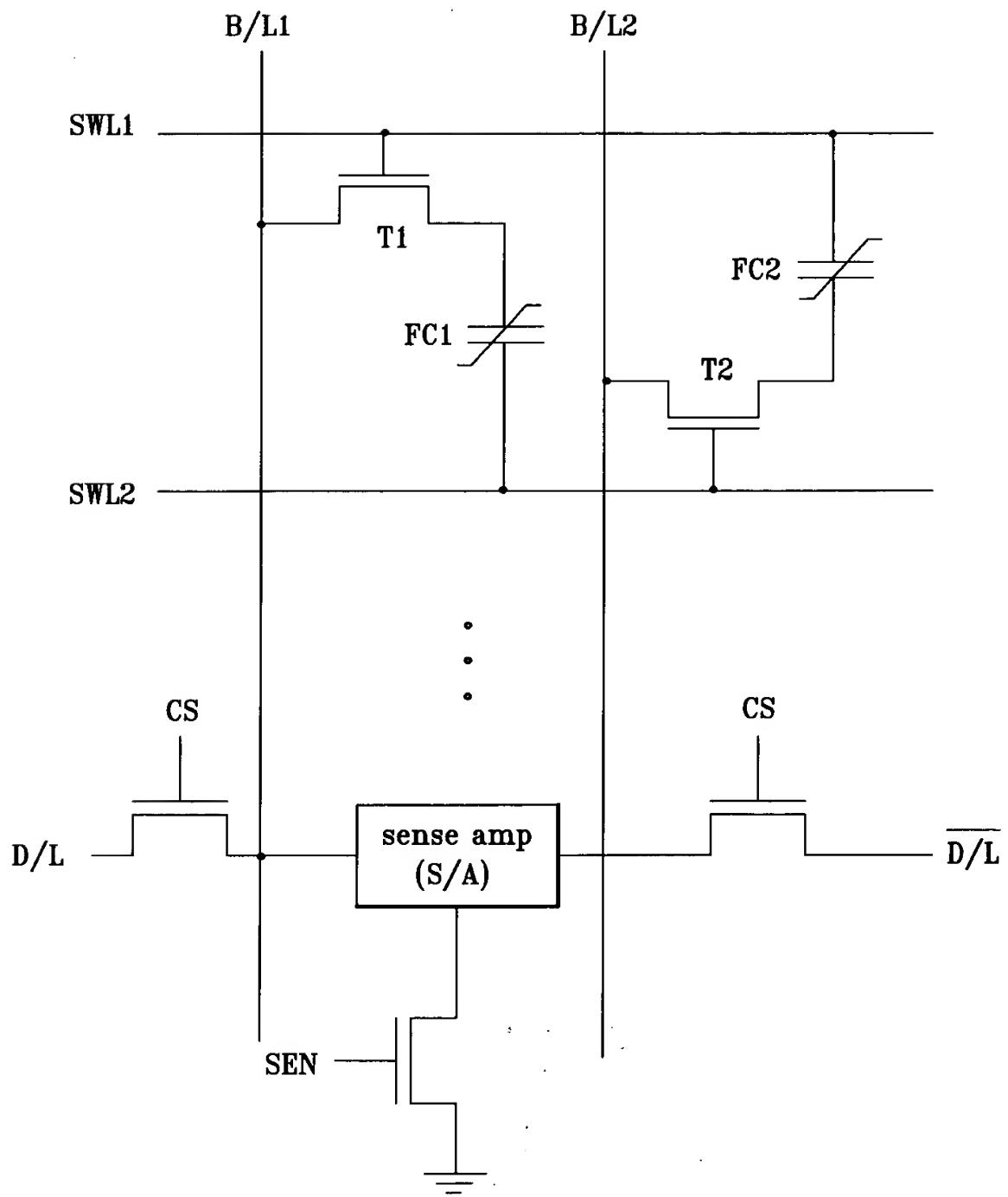


FIG.8

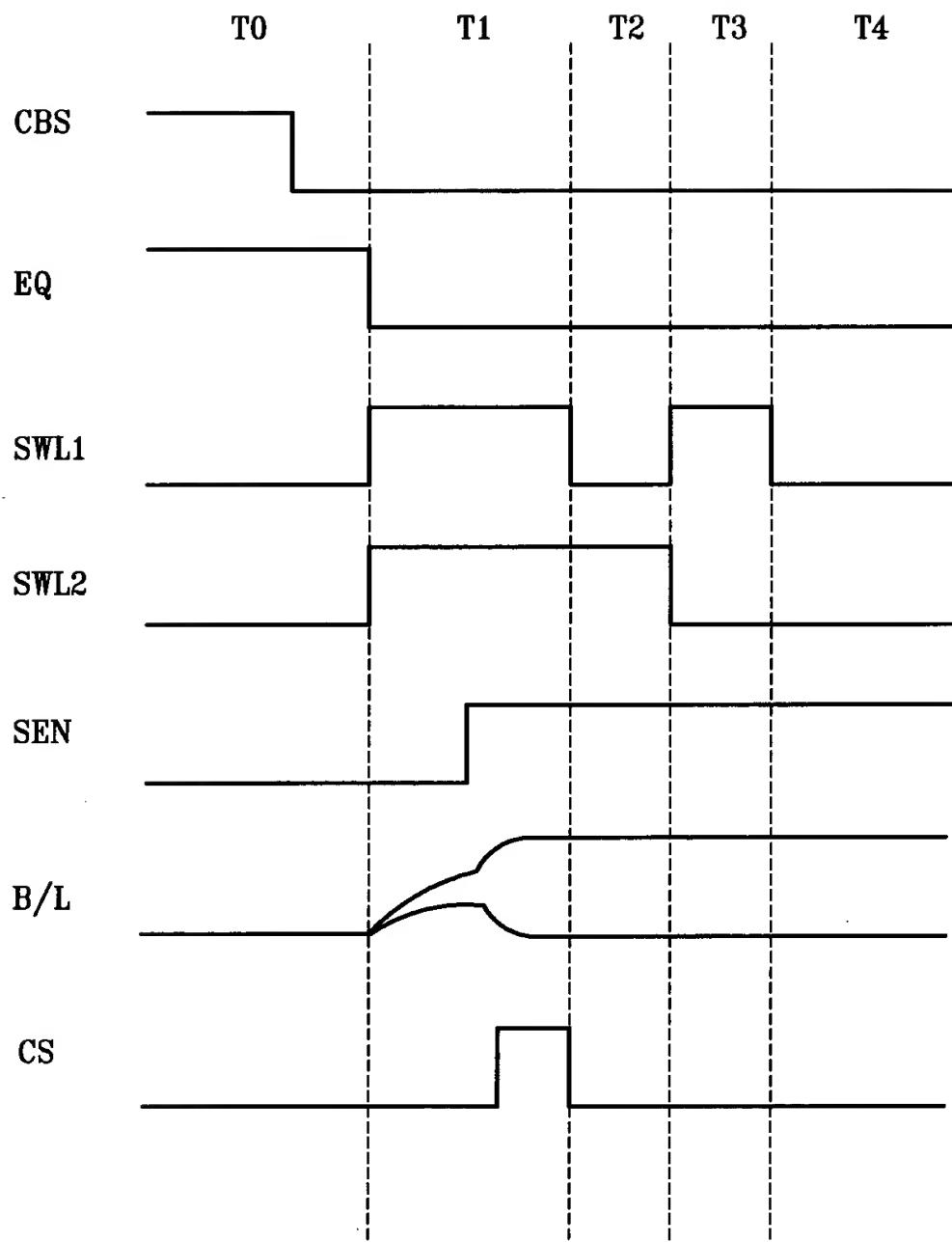


FIG.9

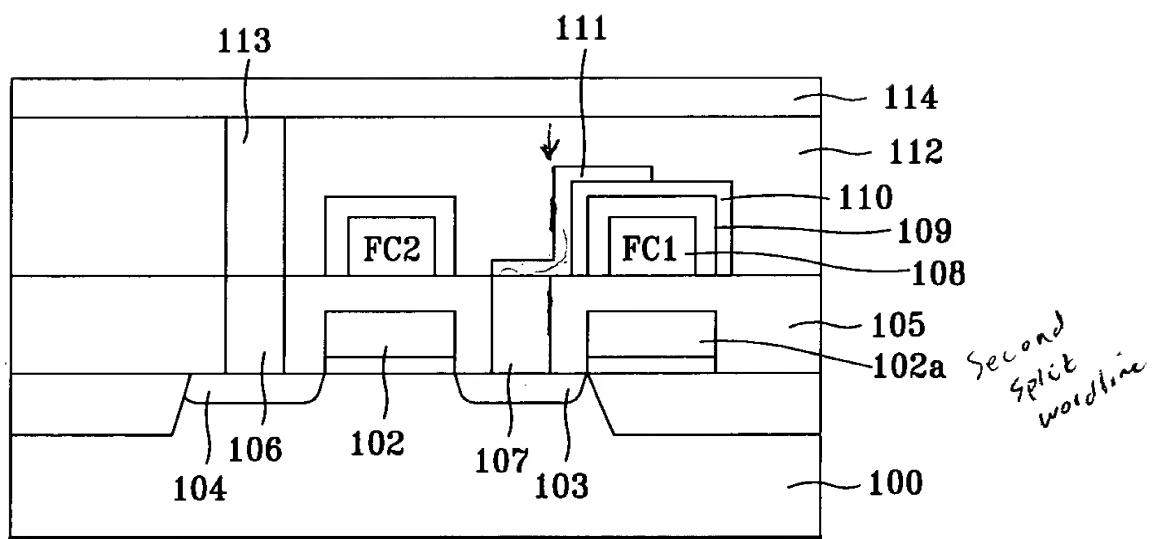


FIG. 10a

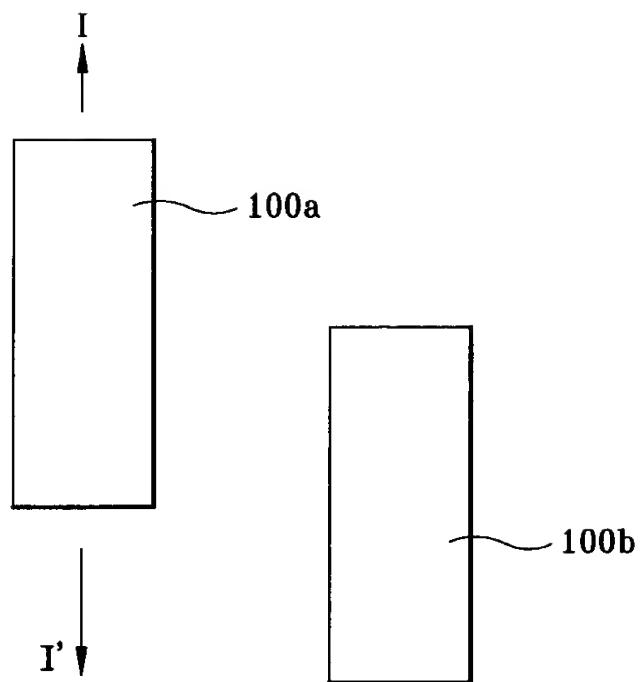


FIG. 10b

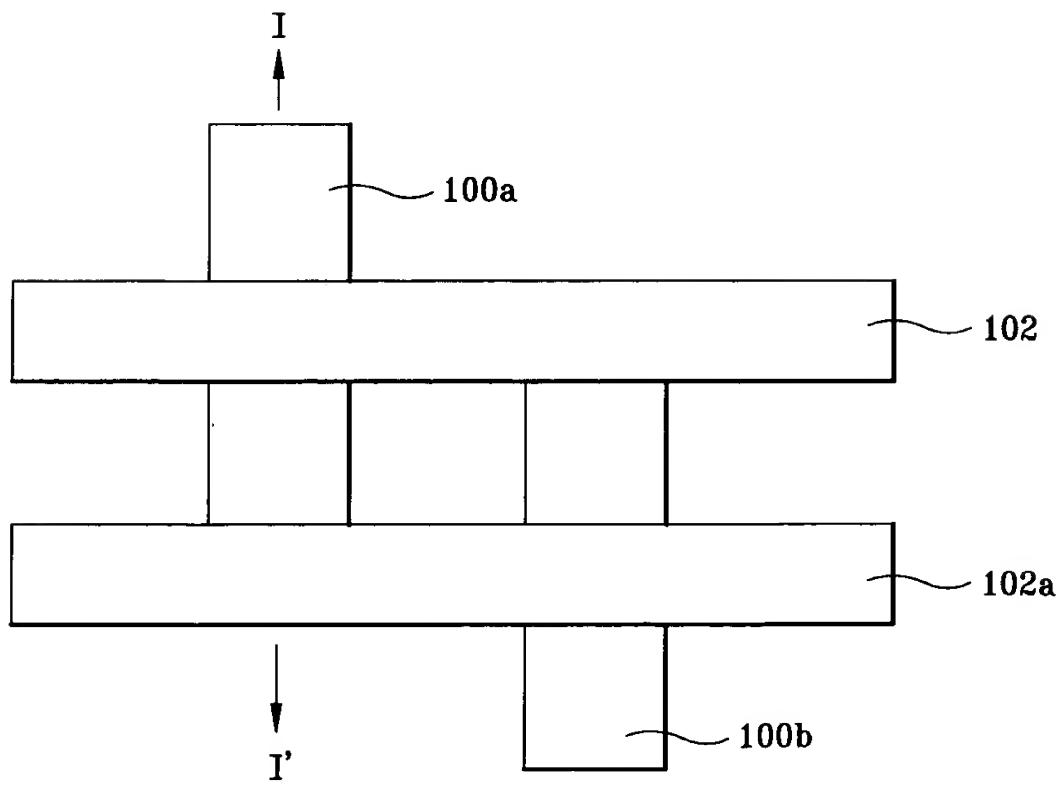


FIG.10c

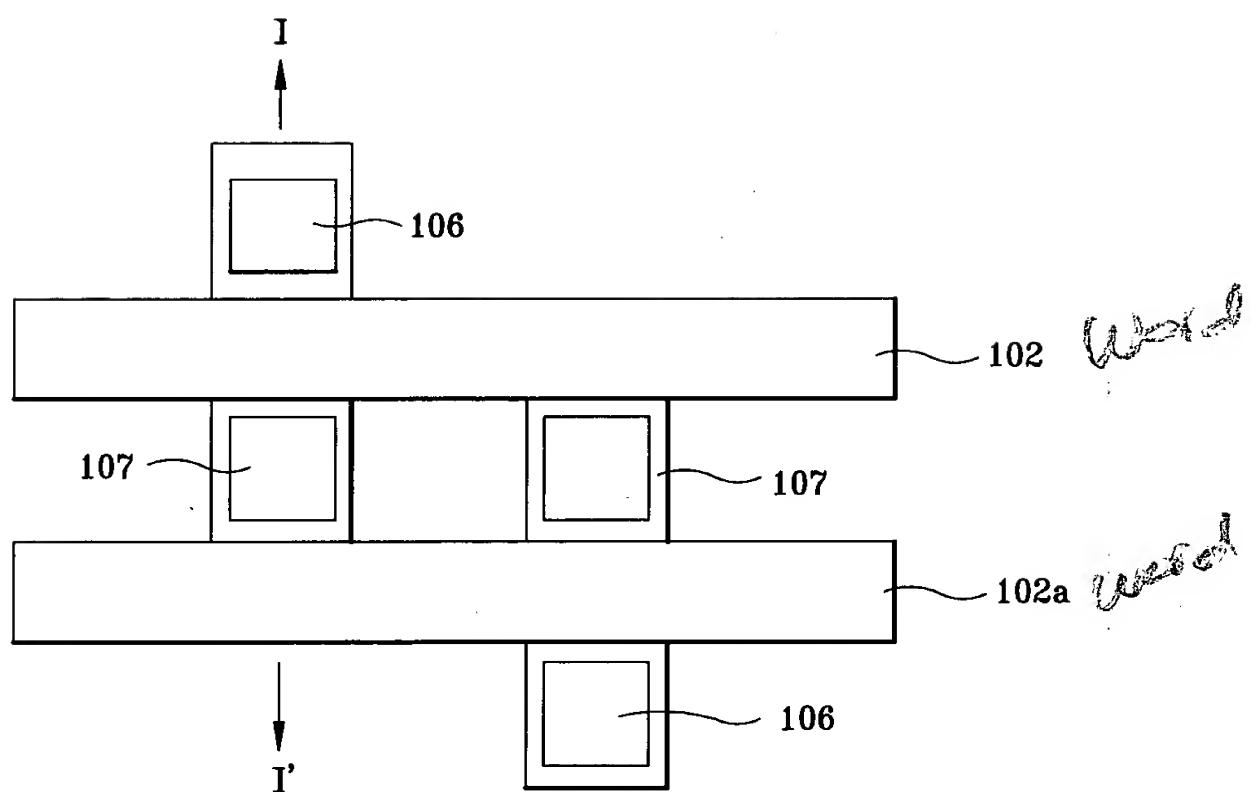


FIG.10d

FIGURE 10d
A perspective view of a stack of components.

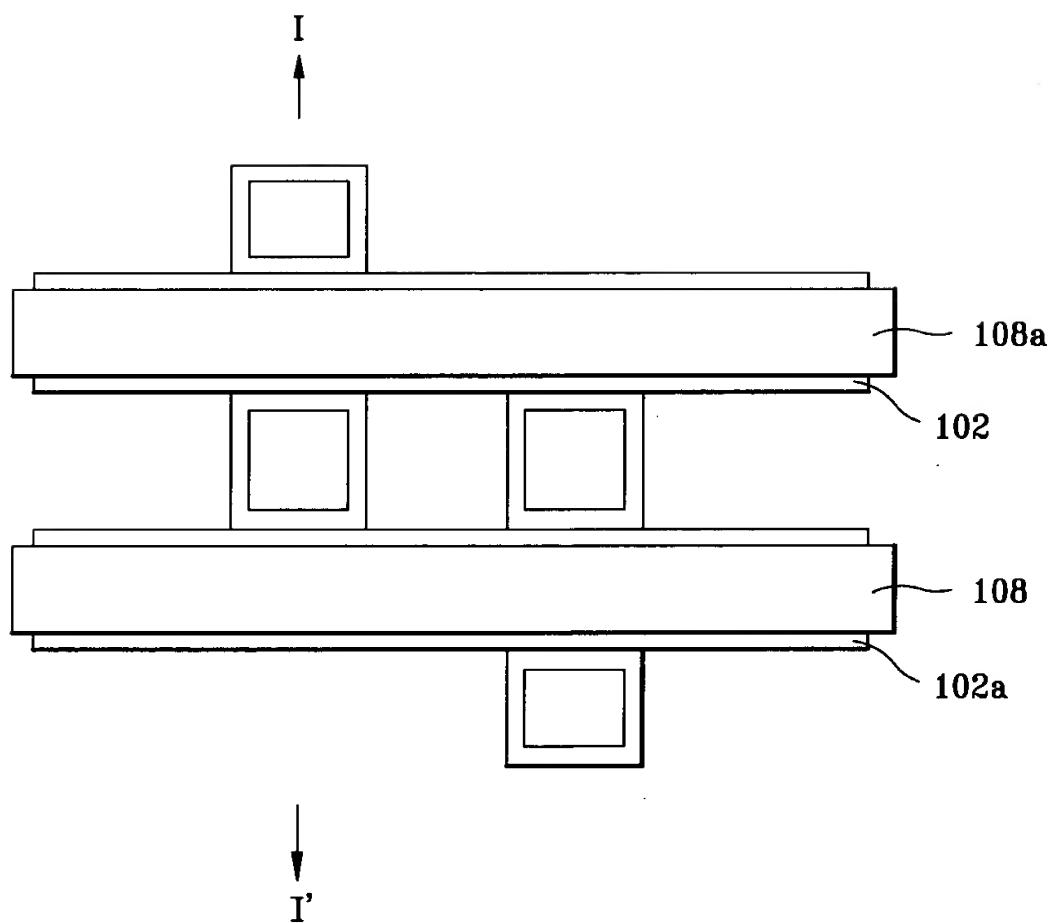
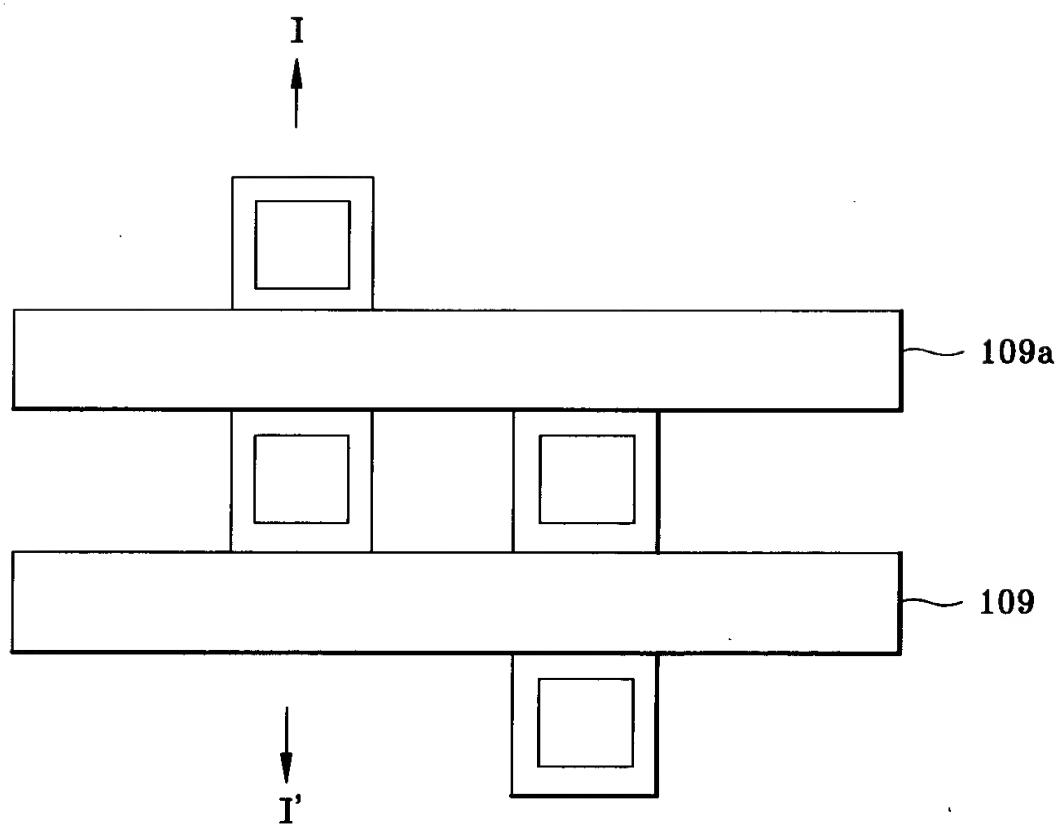


FIG.10e



FIG,10f

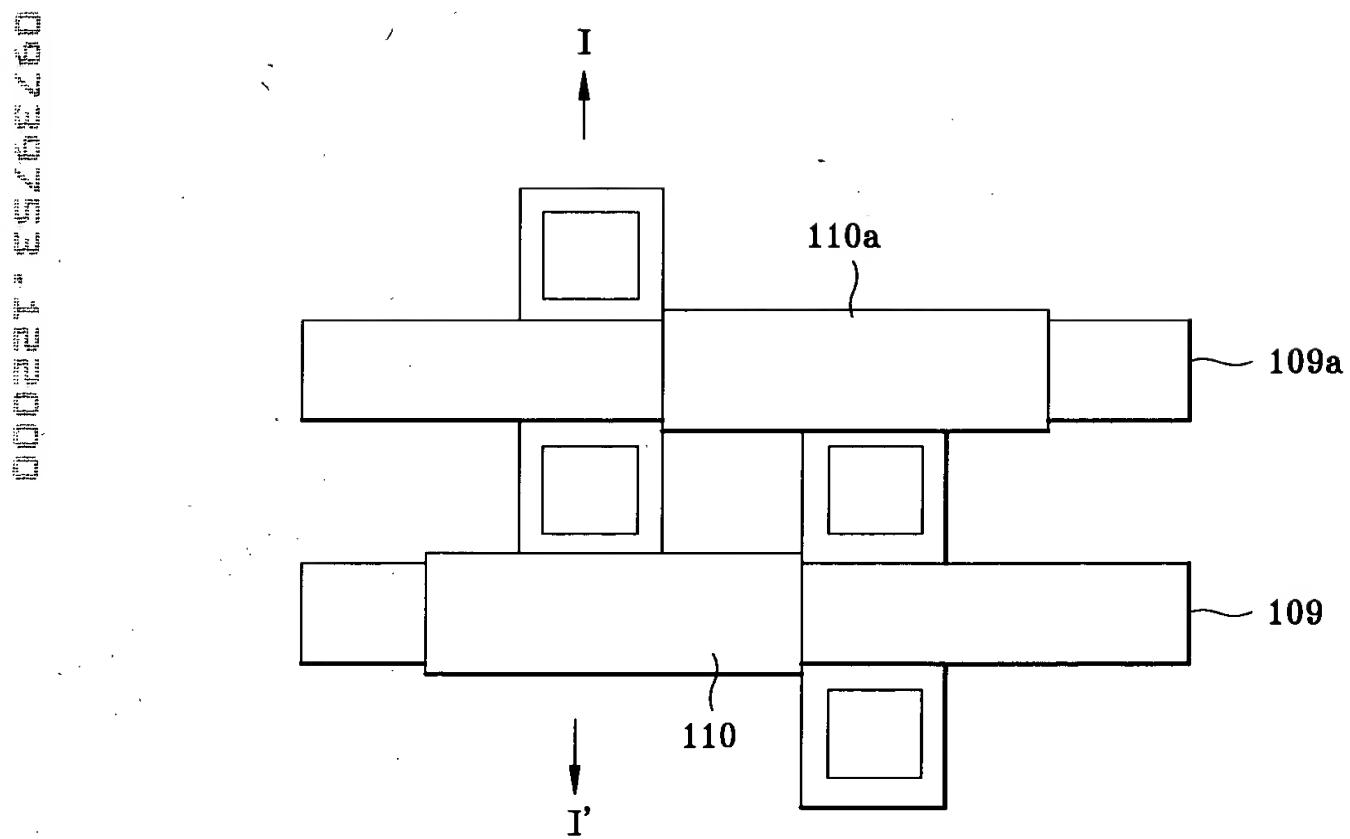


FIG.10g

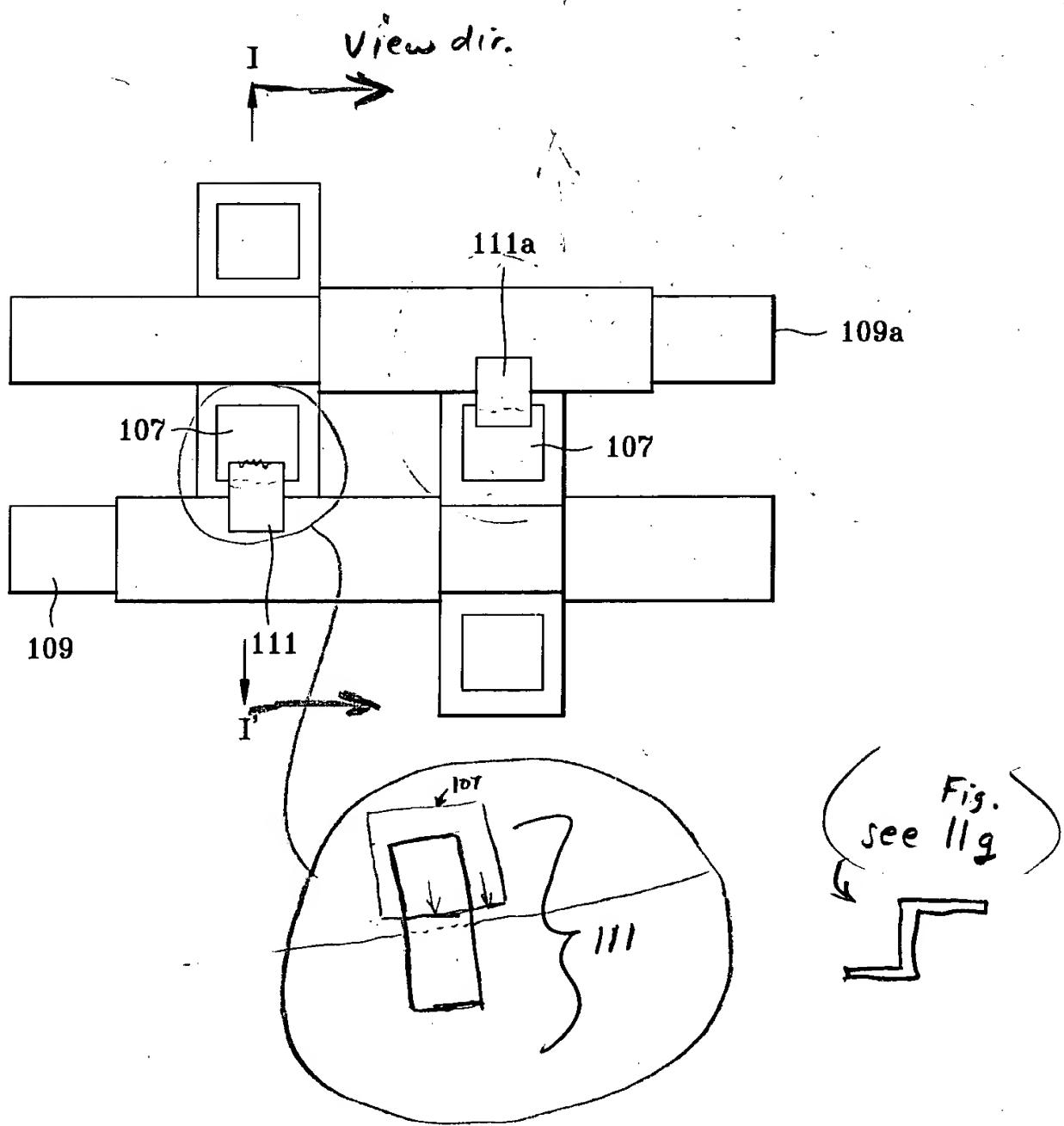


FIG.10h

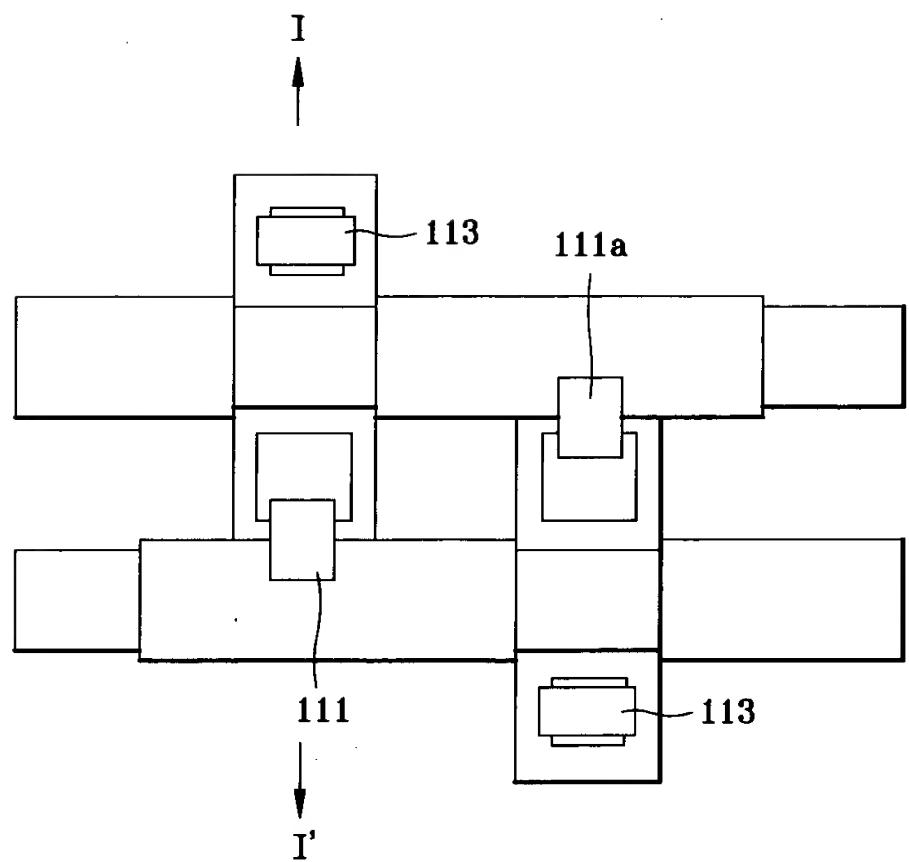


FIG. 10i

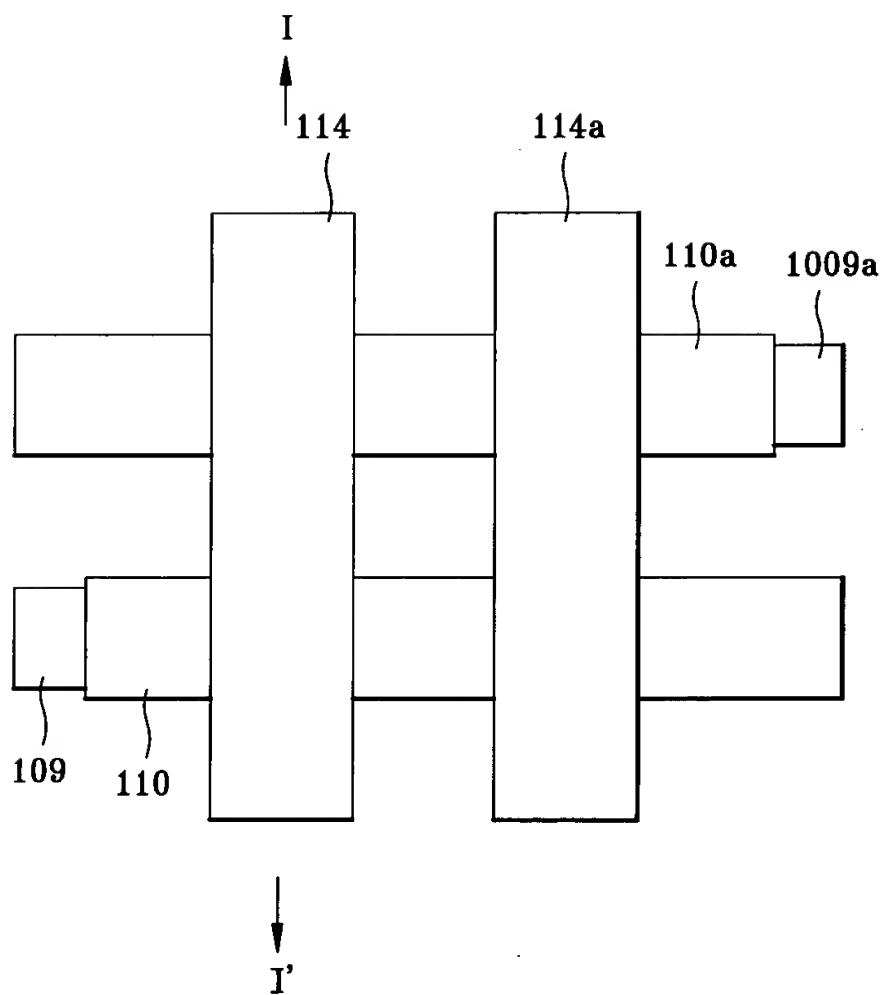


FIG.11a



FIG.11b

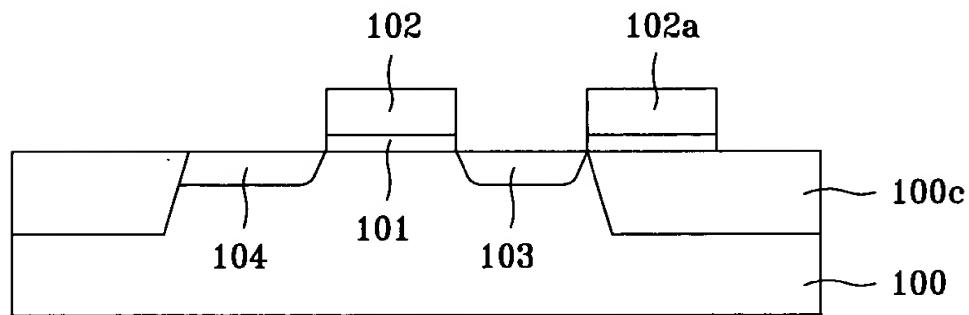


FIG.11c

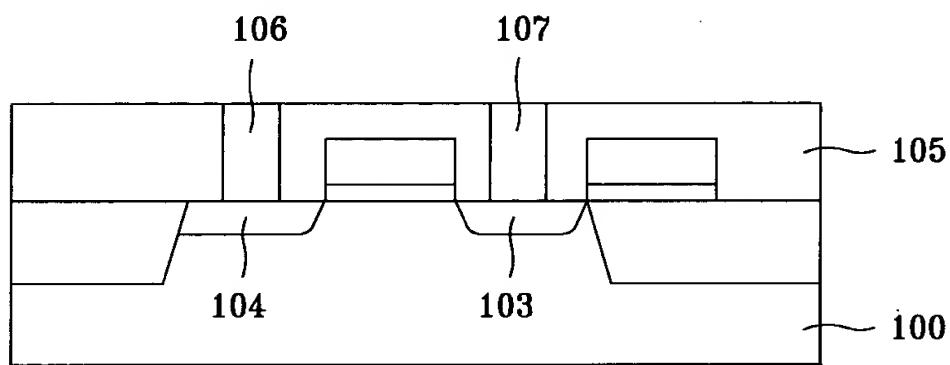


FIG.11d

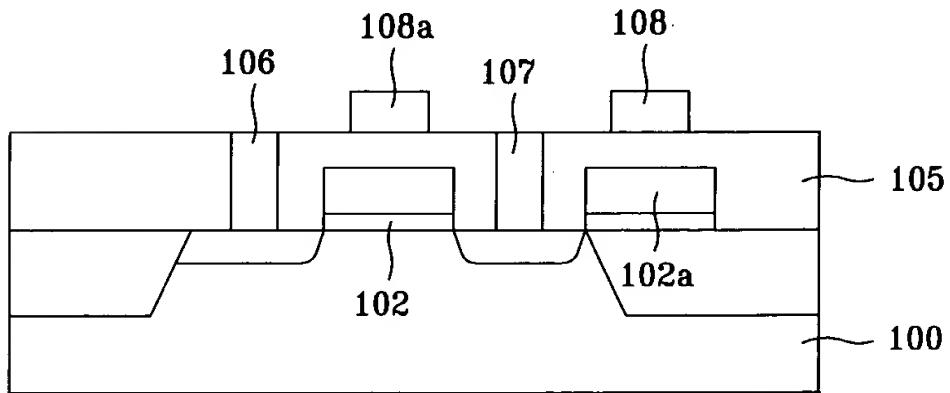


FIG.11e

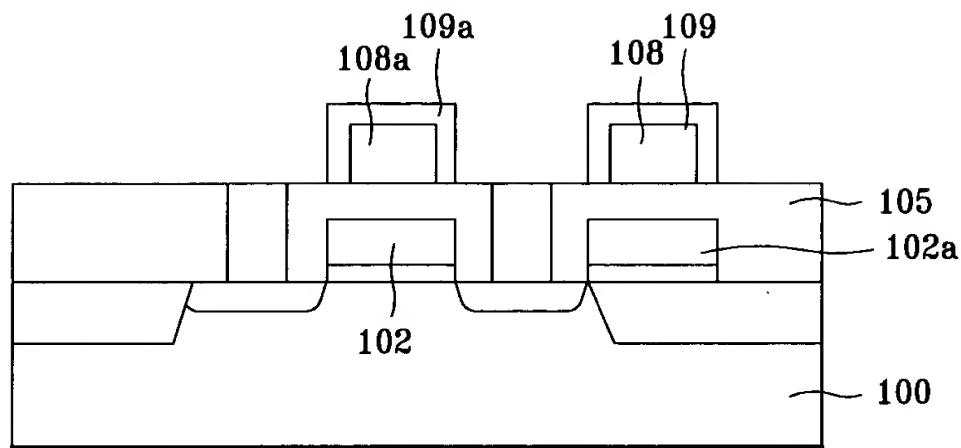


FIG.11f

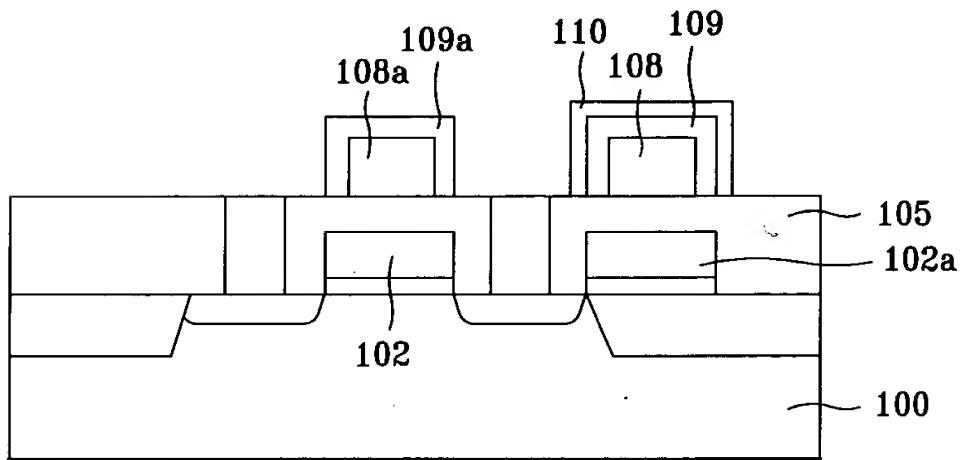


FIG. 11g

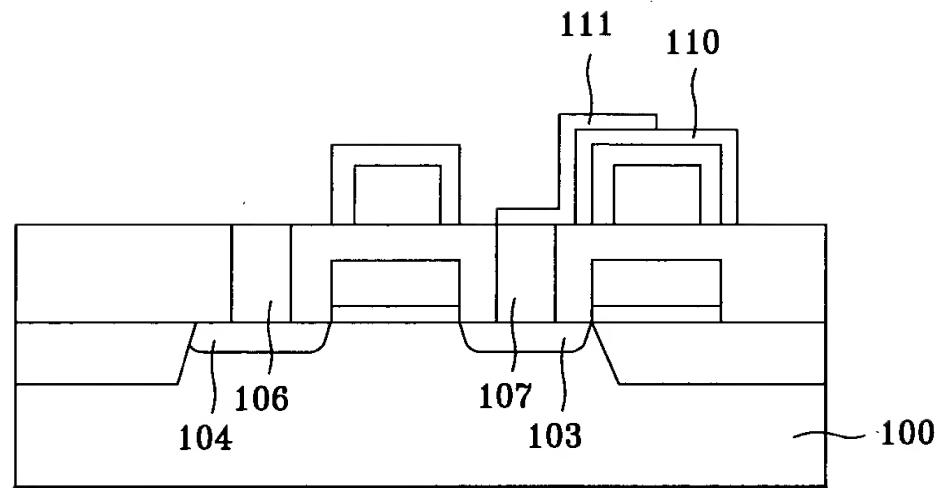


FIG.11h

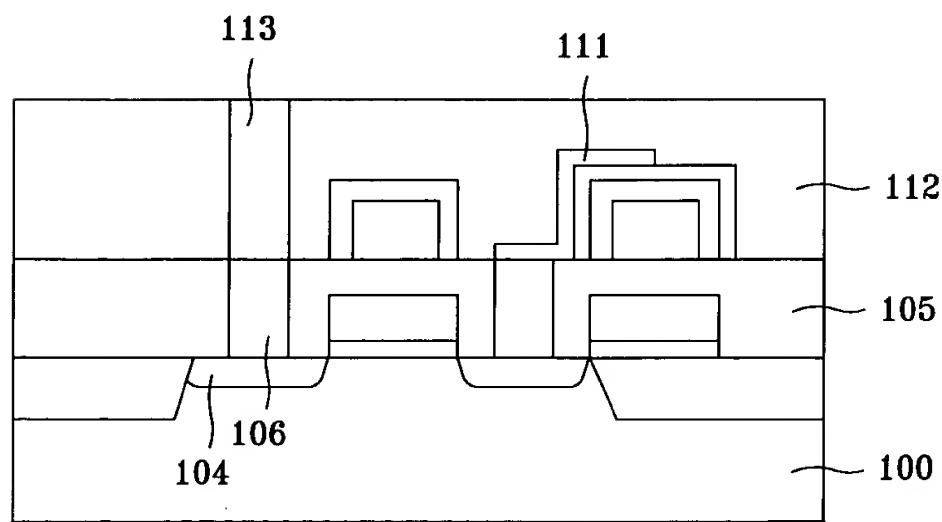


FIG.11i

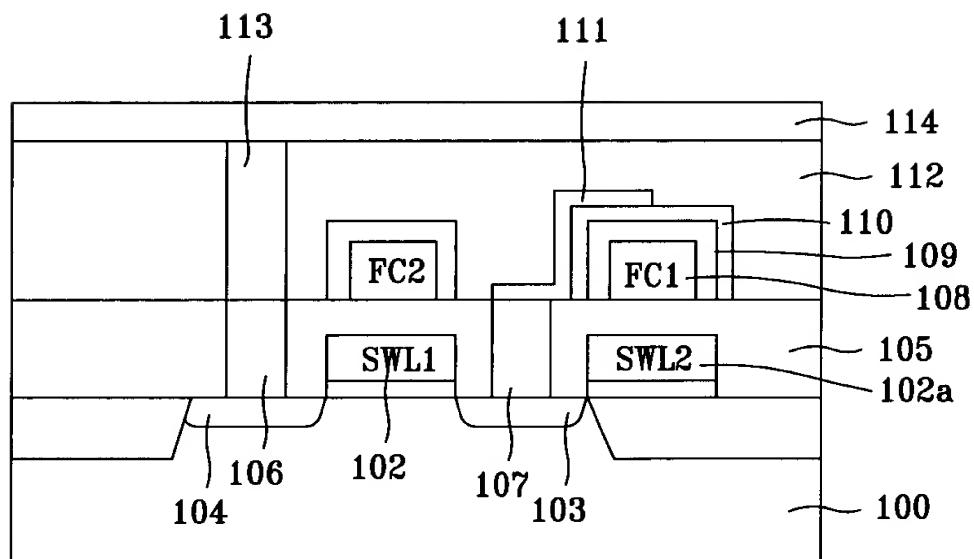
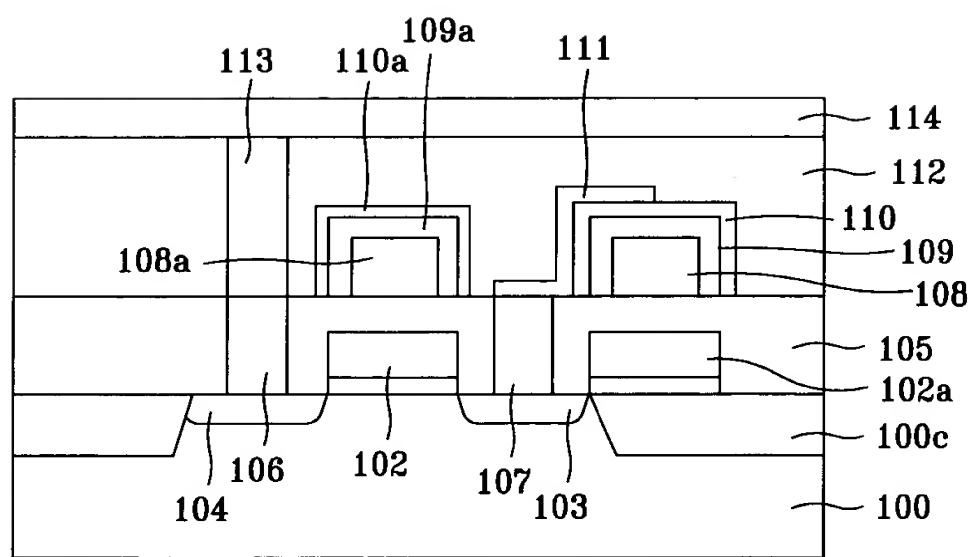


FIG.12



general
view 2nd
emb.

FIG.13a

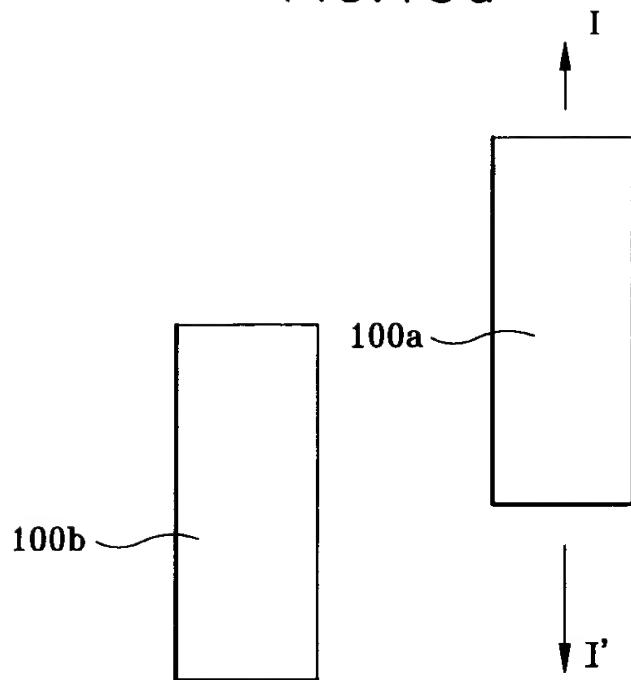
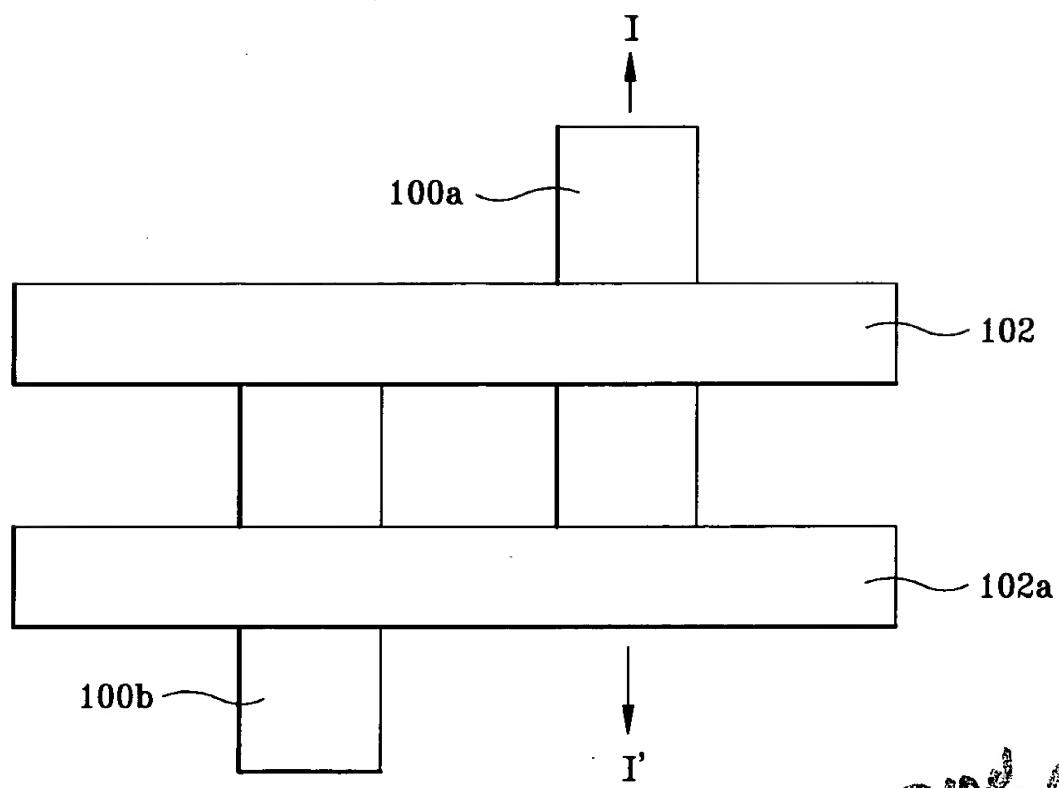


FIG.13b



2nd emb.
Device

FIG.13c

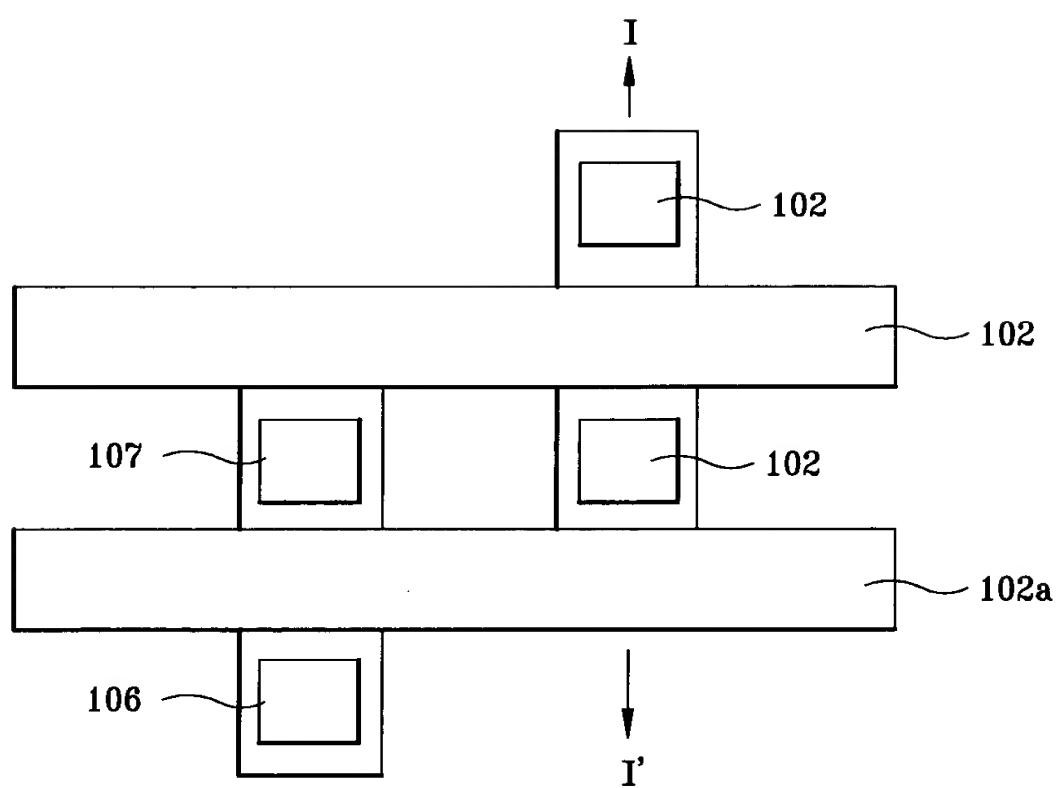


FIG.13d

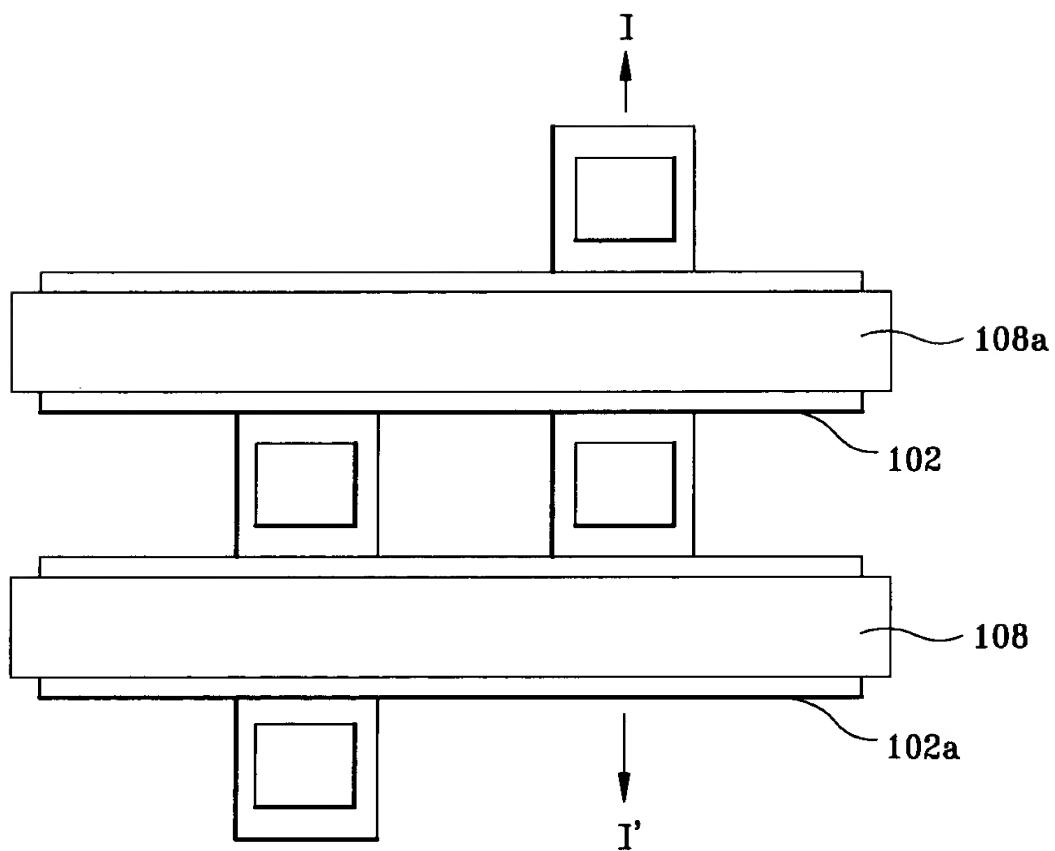


FIG.13e

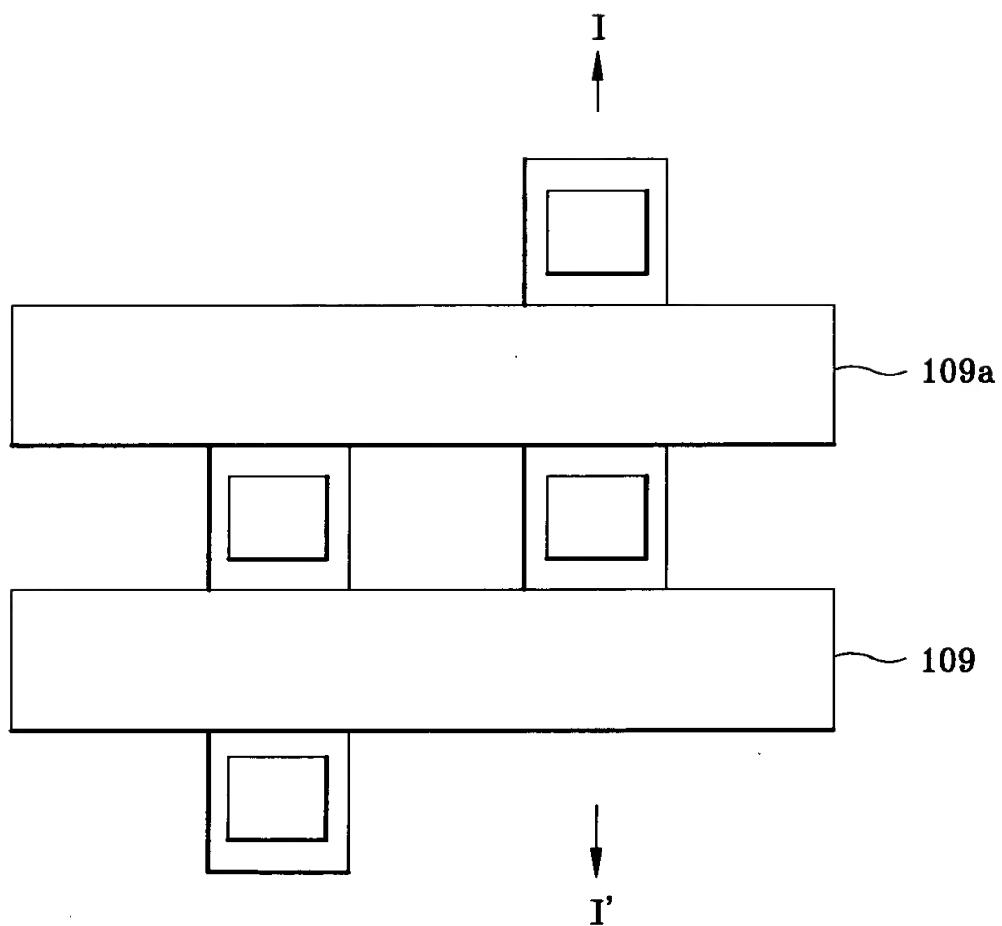


FIG.13f

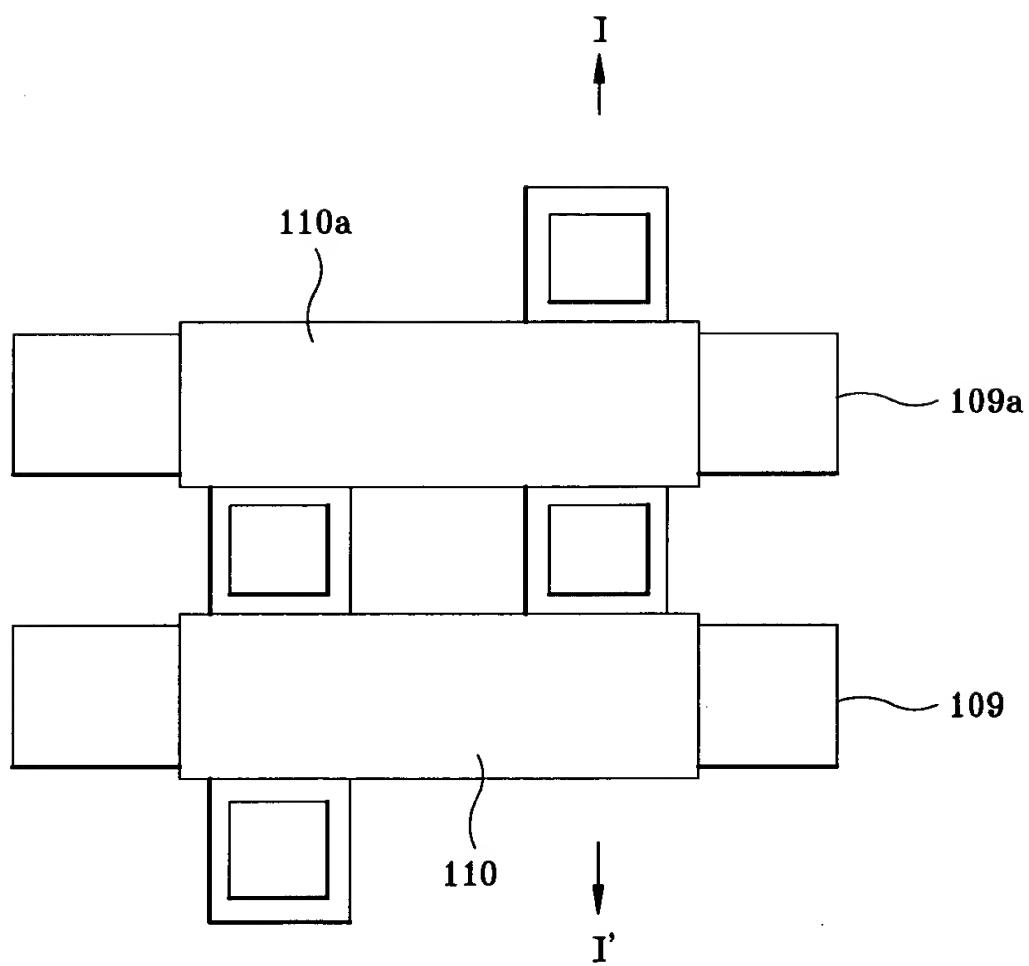


FIG. 13g

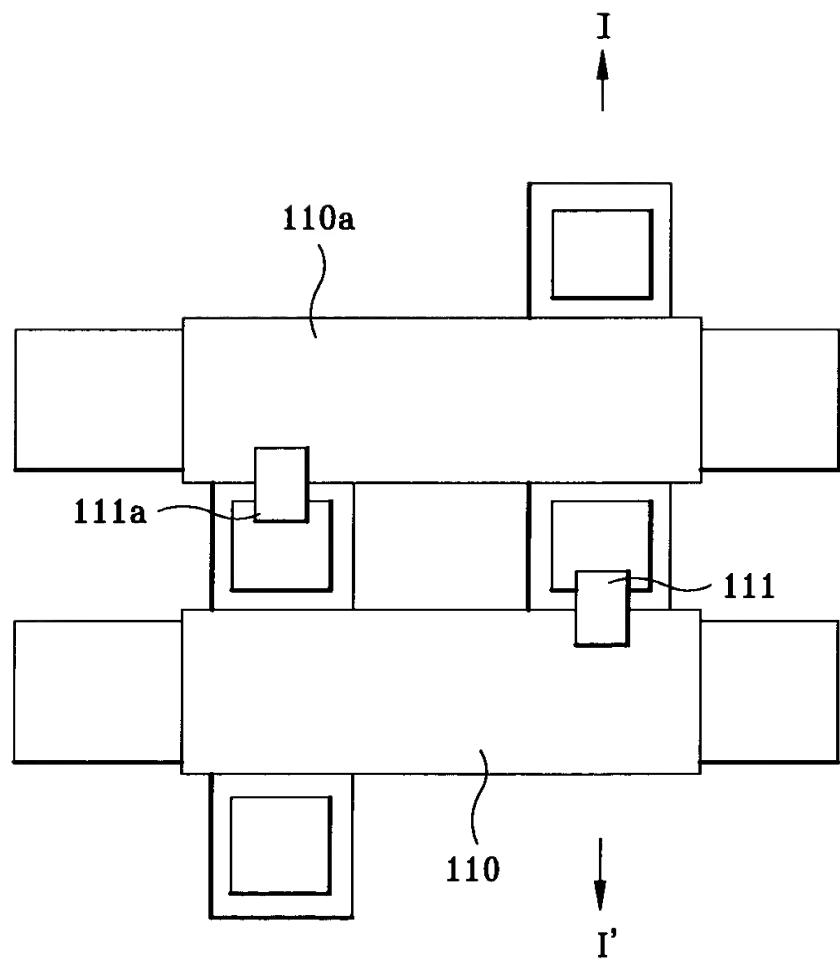


FIG. 13h

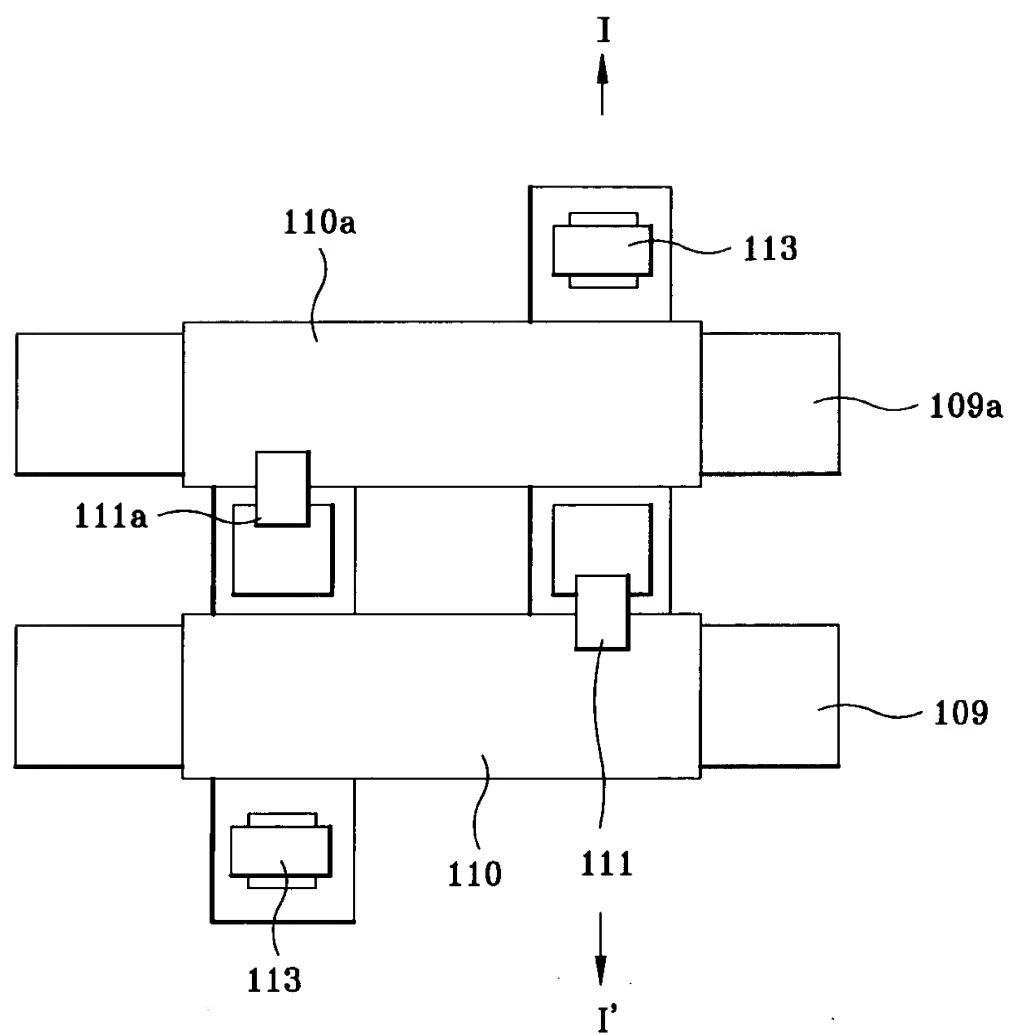


FIG.13i

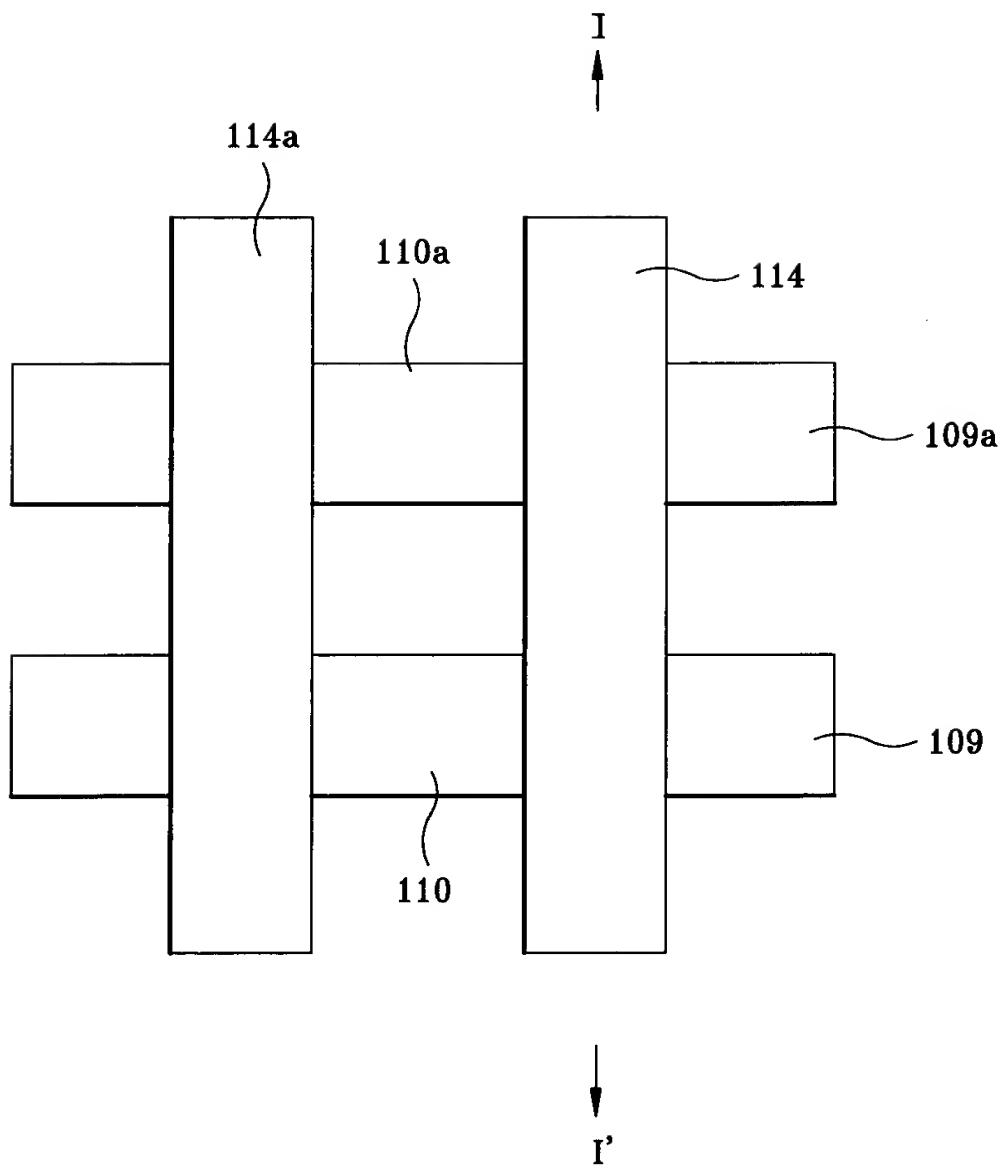


FIG.14a

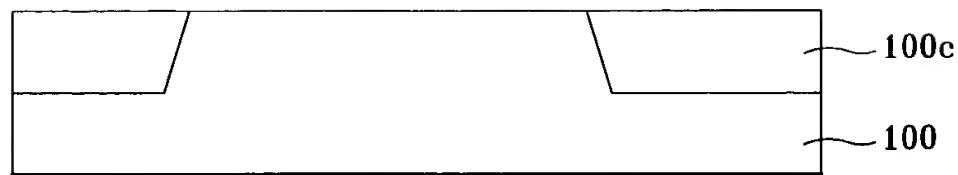


FIG.14b

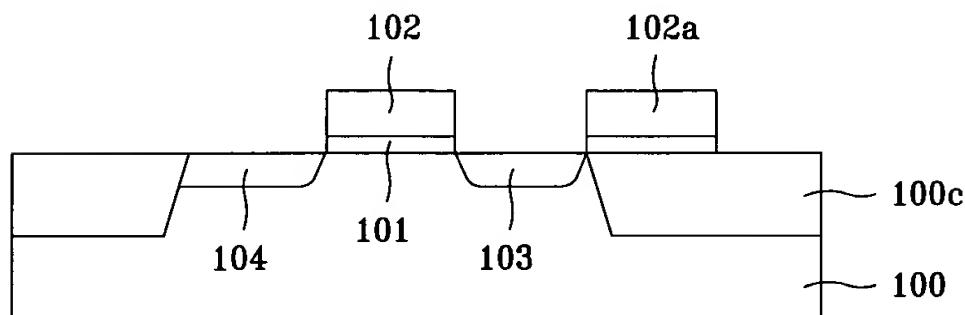


FIG.14c

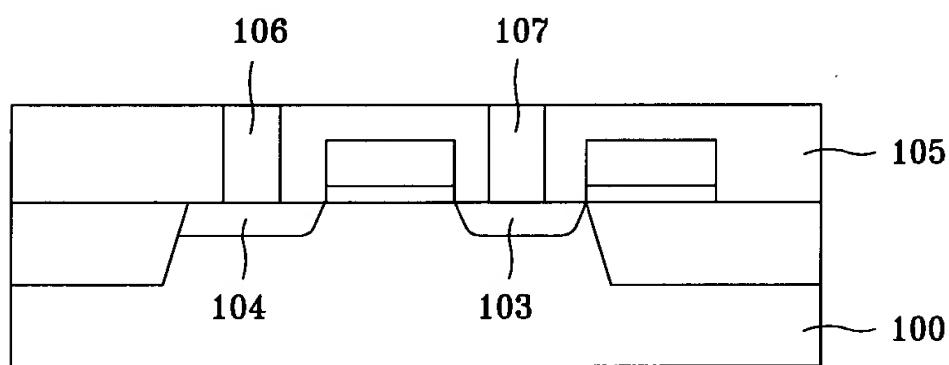
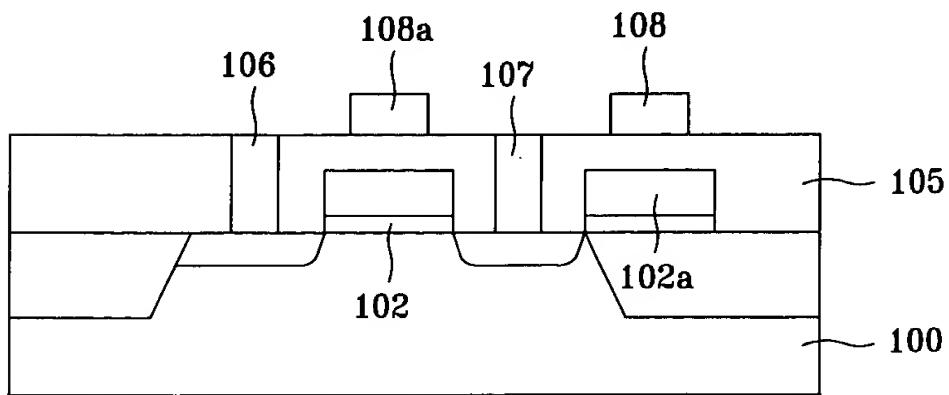


FIG.14d



Method

FIG.14e

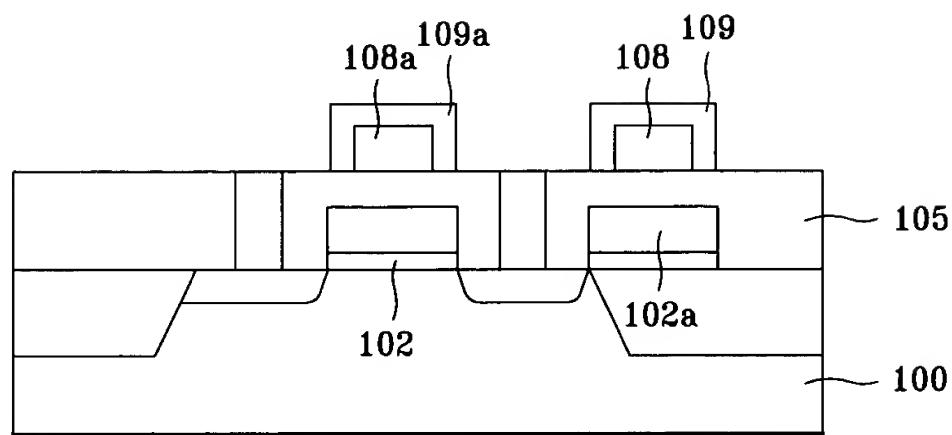


FIG.14f

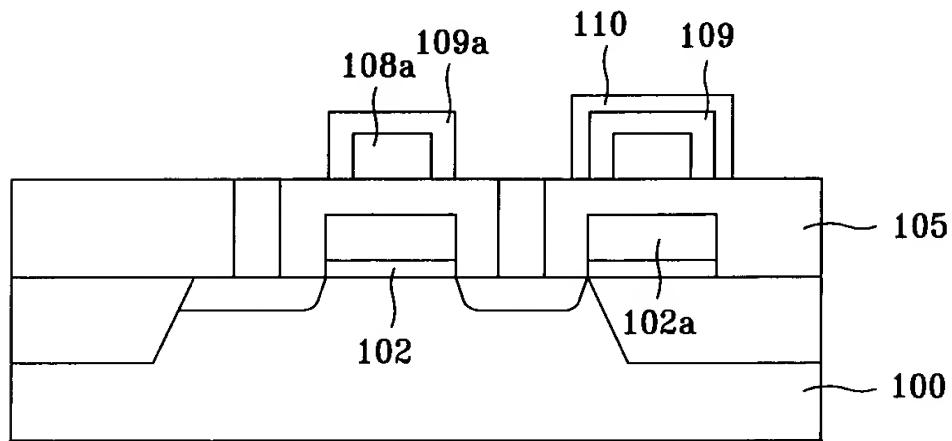


FIG.14g

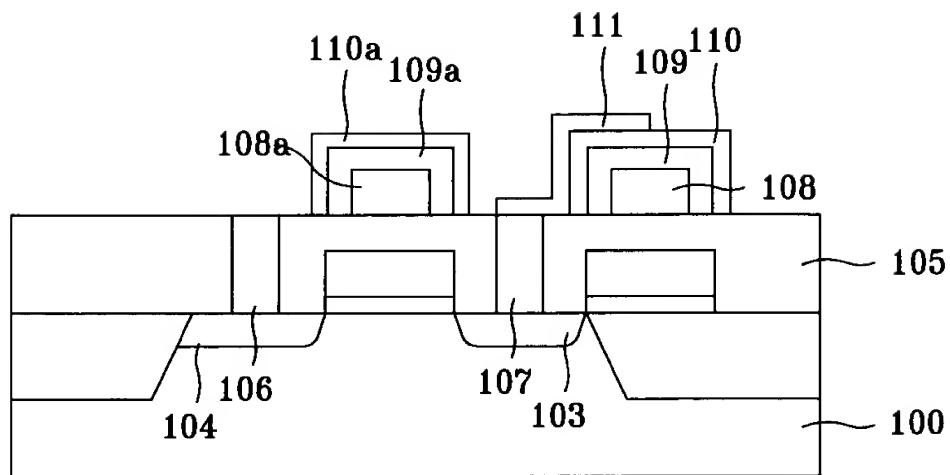


FIG.14h

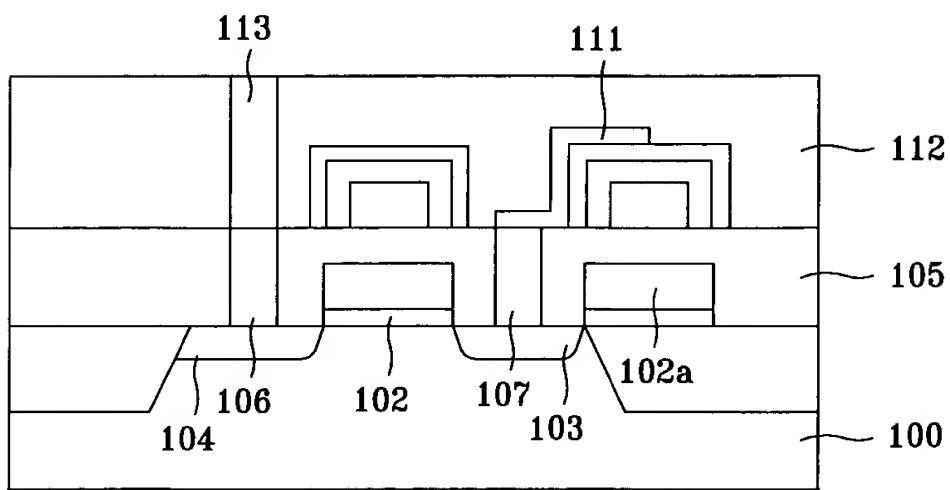


FIG.14i

